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SEMICONDUCTOR®

FDME1024NZT Dual N-Channel PowerTrench[®] MOSFET 20 V, 3.8 A, 66 mΩ

Features

- Max $r_{DS(on)}$ = 66 m Ω at V_{GS} = 4.5 V, I_D = 3.4 A
- Max $r_{DS(on)}$ = 86 m Ω at V_{GS} = 2.5 V, I_D = 2.9 A
- Max $r_{DS(on)}$ = 113 m Ω at V_{GS} = 1.8 V, I_D = 2.5 A
- Max $r_{DS(on)}$ = 160 m Ω at V_{GS} = 1.5 V, I_D = 2.1 A
- Low profile: 0.55 mm maximum in the new package MicroFET 1.6x1.6 Thin
- Free from halogenated compounds and antimony oxides
- HBM ESD protection level > 1600 V (Note 3)
- RoHS Compliant



General Description

This device is designed specifically as a single package solution for dual switching requirement in cellular handset and other ultra-portable applications. It features two independent N-Channel MOSFETs with low on-state resistance for minimum conduction losses.

The MicroFET 1.6x1.6 **Thin** package offers exceptional thermal performance for it's physical size and is well suited to switching and linear mode applications.

Applications

- Baseband Switch
- Load Switch



MicroFET 1.6x1.6 Thin

MOSFET Maximum Ratings TA = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units
V _{DS}	Drain to Source Voltage			20	V
V _{GS}	Gate to Source Voltage			±8	V
ID	Drain Current -Continuous	T _A = 25 °C	(Note 1a)	3.8	
	-Pulsed			6	— A
D	Power Dissipation for Single Operation	T _A = 25 °C	(Note 1a)	1.4	14/
P _D	Power Dissipation for Single Operation $T_A = 25 \text{ °C}$ (Note 1b)		(Note 1b)	0.6	W
T _J , T _{STG}	Operating and Storage Junction Temperation	ature Range		-55 to +150	°C

Thermal Characteristics

$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (Single Operation)	(Note 1a)	90	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient (Single Operation)	(Note 1b)	195	C/ W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
4T	FDME1024NZT	MicroFET 1.6x1.6 Thin	7 "	8 mm	5000 units

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_{D} = 250 \ \mu A, \ V_{GS} = 0 \ V$	20			V
ΔBV _{DSS} ΔTJ	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		16		mV/°C
IDSS	Zero Gate Voltage Drain Current	V _{DS} = 16 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 8 \text{ V}, V_{DS} = 0 \text{ V}$			±10	μA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS}=V_{DS},\ I_{D}=250\ \mu A$	0.4	0.7	1.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 250 $\mu A,$ referenced to 25 °C		-3		mV/°C
	Static Drain to Source On Resistance	$V_{GS} = 4.5 \text{ V}, \ \text{I}_{D} = 3.4 \text{ A}$		55	66	
		$V_{GS} = 2.5 \text{ V}, \ \text{I}_{D} = 2.9 \text{ A}$		68	86	mΩ
DS(on)		$V_{GS} = 1.8 \text{ V}, \ \text{I}_{D} = 2.5 \text{ A}$		85	113	
		$V_{GS} = 1.5 \text{ V}, \ \text{I}_{D} = 2.1 \text{ A}$		106	160	
		$V_{GS} = 4.5 \text{ V}, \ I_D = 3.4 \text{ A}, \ T_J = 125 \ ^\circ\text{C}$		76	112	
9 _{FS}	Forward Transconductance	$V_{DD} = 4.5 \text{ V}, \ \text{I}_{D} = 3.4 \text{ A}$		9		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance			225	300	pF
C _{oss}	Output Capacitance	— V _{DS} = 10 V, V _{GS} = 0 V, — f = 1 MHz		40	55	pF
C _{rss}	Reverse Transfer Capacitance			25	40	pF
	Characteristics					<u>.</u>
t _{d(on)}	Turn-On Delay Time			4.5	10	ns

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t _{d(on)}	Turn-On Delay Time			4.5	10	ns
t _r	Rise Time	$V_{DD} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ A},$		2	10	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 4.5 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		15	27	ns
t _f	Fall Time			1.7	10	ns
Qg	Total Gate Charge	V 40.V.L 0.4.A		3	4.2	nC
Q _{gs}	Gate to Source Gate Charge	$V_{DD} = 10 \text{ V}, \text{ I}_{D} = 3.4 \text{ A},$ $V_{GS} = 4.5 \text{ V}$		0.4		nC
Q _{gd}	Gate to Drain "Miller" Charge	VGS - 7.5 V		0.6		nC

Drain-Source Diode Characteristics

V_{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 0.9 A$ (Note 2		0.7	1.2	V
t _{rr}	Reverse Recovery Time	I _F = 3.4 A, di/dt = 100 A/μs		8.5	17	ns
Q _{rr}	Reverse Recovery Charge			1.4	10	nC

NOTES:

R_{θJA} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{θJC} is guaranteed by design while R_{θCA} is determined by the user's board design.



2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.

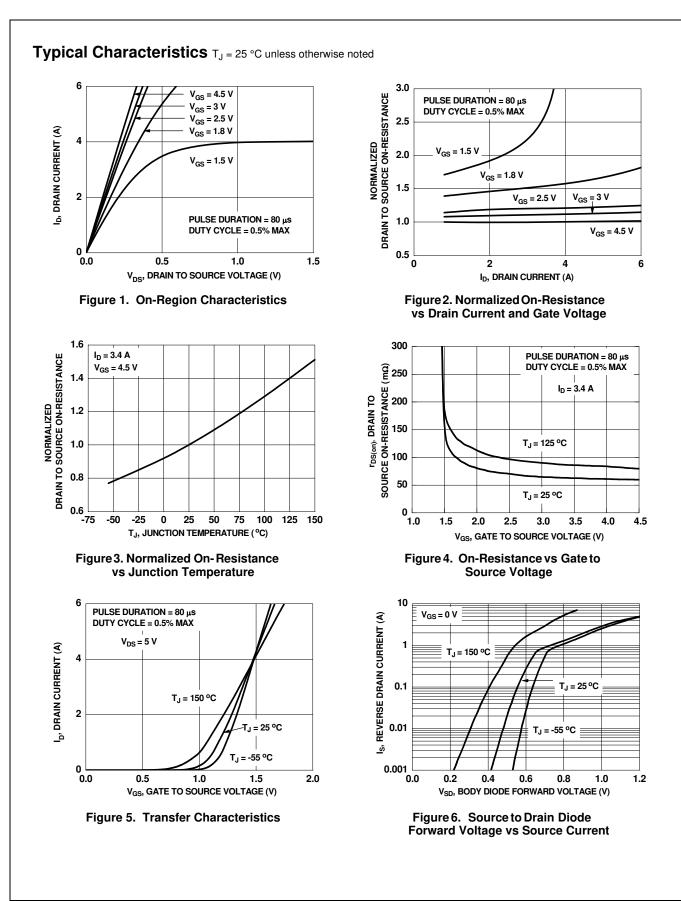
a. 90 °C/W when mounted on a 1 in² pad of 2 oz copper.

3. The diode connected between the gate and source serves only as protection ESD. No gate overvoltage rating is implied.



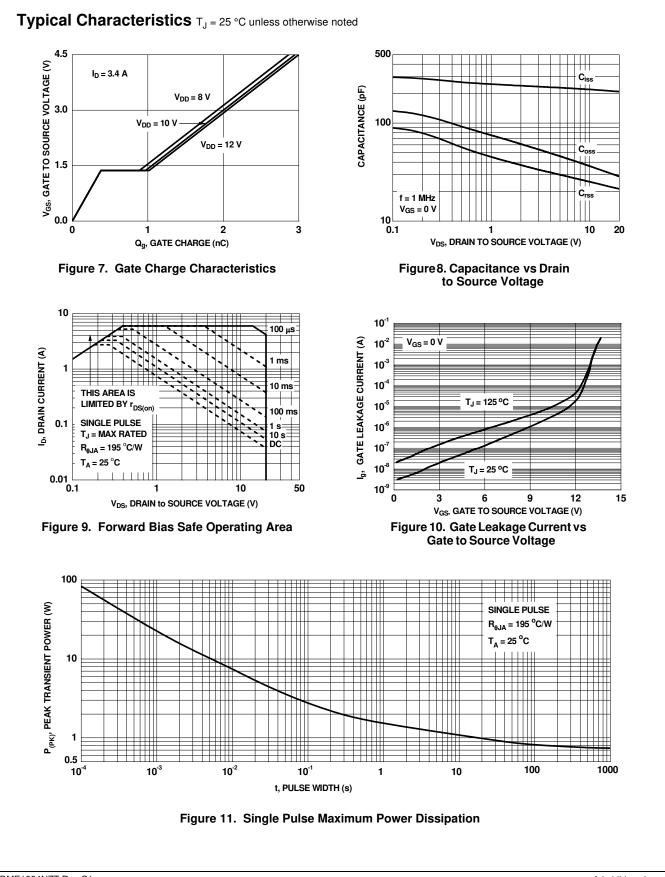
b. 195 °C/W when mounted on a minimum pad of 2 oz copper.





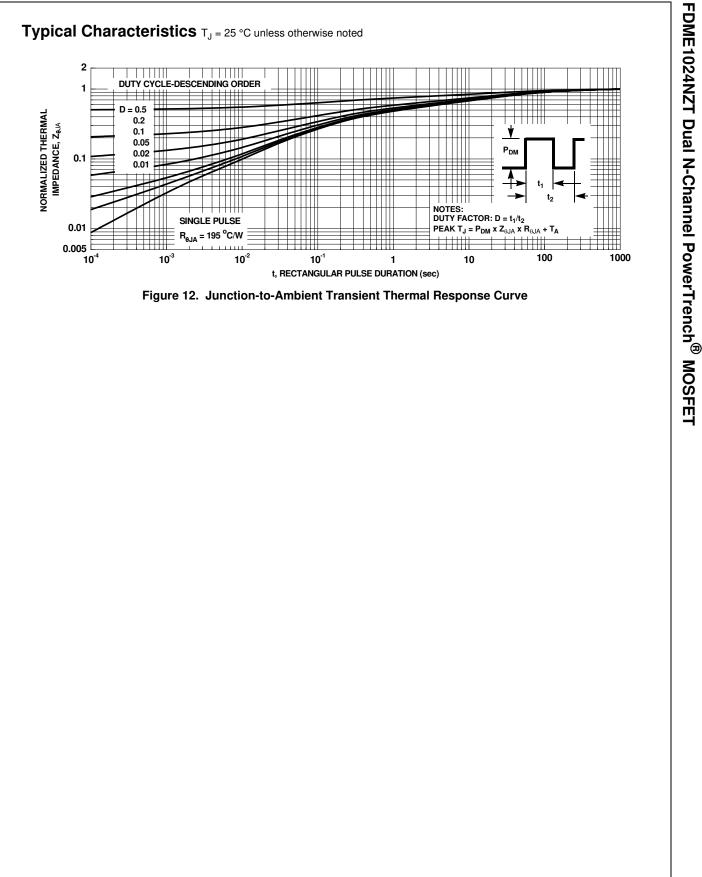
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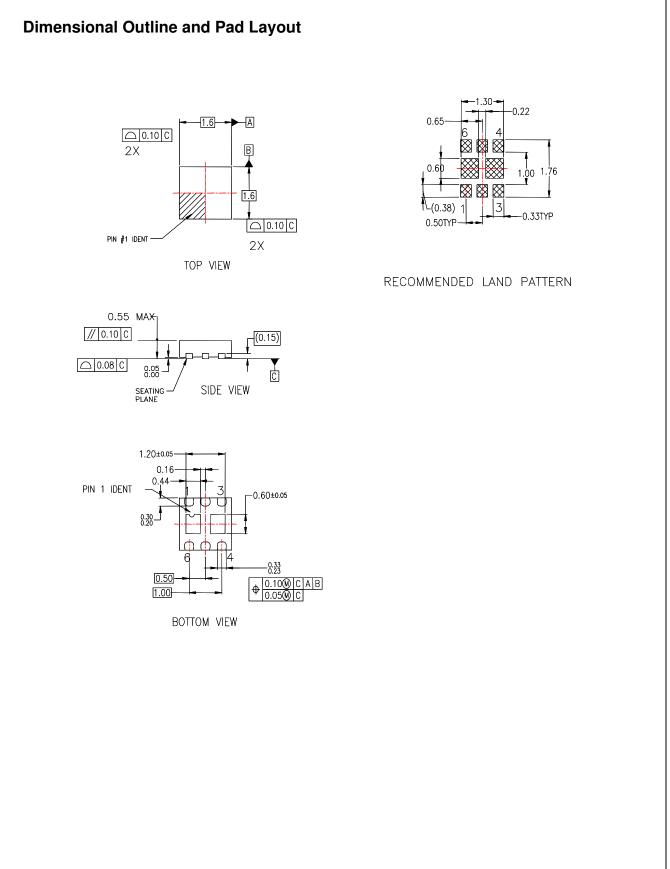


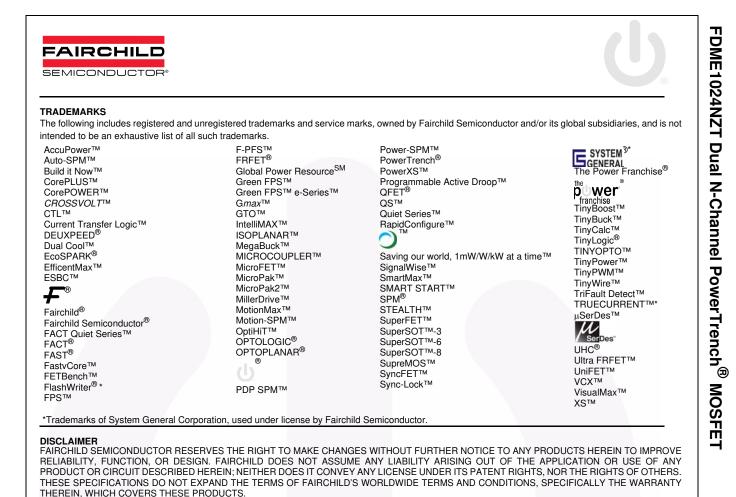
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FDME1024NZT Dual N-Channel PowerTrench[®] MOSFET



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